

Description

The BSC030P03NS3G uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = -30V I_{D} = -100A$

 $R_{DS(ON)} < 4 \text{ m}\Omega \text{ V}_{GS} = -10 \text{V}$

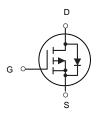
Application

Battery protection

Load switch

Uninterruptible power supply

DFN5X6-8L



P-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
BSC030P03NS3G	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (Tc=25 ℃ unless otherwise noted)

Symbol	Parameter	Rating	Units	
VDS	Drain-Source Voltage	-30	V	
Vgs	Gate-Source Voltage	V		
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹	Α		
Io@Tc=100°C	Continuous Drain Current, V _{GS} @ 10V ¹	-70	Α	
Ірм	Pulsed Drain Current ² -250		А	
EAS	Single Pulse Avalanche Energy ³ 80		mJ	
las	Avalanche Current	Avalanche Current -70		
P _D @T _C =25°C	Total Power Dissipation ⁴	120	W	
Тѕтс	Storage Temperature Range -55 to 150		°C	
TJ	Operating Junction Temperature Range -55 to 150		°C	
Reja	Thermal Resistance Junction-Ambient ¹	ermal Resistance Junction-Ambient ¹ 50		
Rejc	Thermal Resistance Junction-Case ¹		°C/W	

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV_DSS	Drain-Source Breakdown Voltage	V_{GS} =0V , I_D =-250uA	-30			V
В	Static Drain-Source On-Resistance ²	V _{GS} =-10V , I _D =-20A		3	4.0	mΩ
$R_{DS(ON)}$	Static Drain-Source On-Resistance-	V _{GS} =-4.5V , I _D =-15A		4.2	6.0	mΩ
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_D=-250uA$	-1.2		-2.5	V
	Drain-Source Leakage Current	V _{DS} =-24V , V _{GS} =0V , T _J =25°C			-1	uA
I _{DSS}		V _{DS} =-24V , V _{GS} =0V , T _J =55°C			-5	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.2		Ω
Qg	Total Gate Charge (-10V)			60		
Q_{gs}	Gate-Source Charge	V _{DS} =-15V , V _{GS} =-10V , I _D =-18A		9		nC
Q_{gd}	Gate-Drain Charge			15		
$T_{d(on)}$	Turn-On Delay Time			17		
T _r	Rise Time	V_{DD} =-15V , V_{GS} =-10V , R_{G} =3.3 Ω ,		40		ns
T _{d(off)}	Turn-Off Delay Time	I _D =-20A		55		
T _f	Fall Time			13		
C _{iss}	Input Capacitance			3450		
C _{oss}	Output Capacitance	V _{DS} =-25V , V _{GS} =0V , f=1MHz		255		pF
C_{rss}	Reverse Transfer Capacitance			140		
Is	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current			-100	Α
V_{SD}	Diode Forward Voltage ²	V_{GS} =0 V , I_{S} =-1 A , T_{J} =25 $^{\circ}$ C			-1.2	V
t _{rr}	Reverse Recovery Time	IF=-20A , di/dt=100A/μs ,		22		nS
Q _{rr}	Reverse Recovery Charge	T _J =25℃		72		nC

Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leqq 300 us$, duty cycle $\leqq 2\%$
- 3.The EAS data shows Max. rating . The test condition is V_{DD} =-50V, V_{GS} =-10V,L=0.1mH,I_{AS}=-40A 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation
- 6. The maximum current rating is package limited.

Typical Characteristics

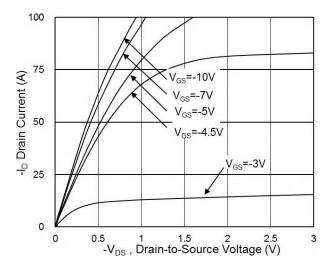


Fig.1 Typical Output Characteristics

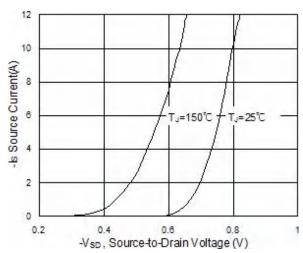


Fig.3 Source Drain Forward Characteristics

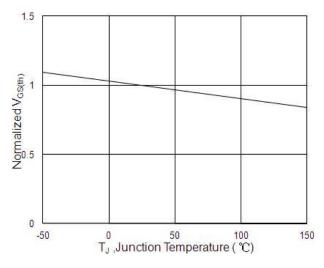


Fig.5 Normalized - $V_{GS(th)}$ vs T_J

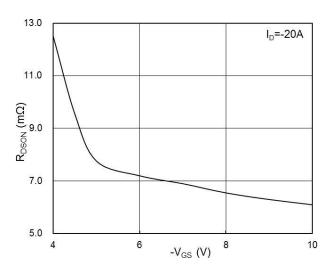


Fig.2 On-Resistance vs G-S Voltage

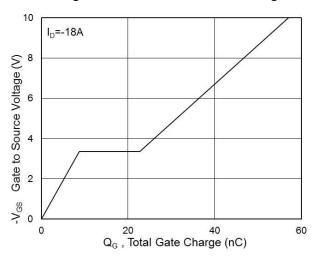


Fig.4 Gate-Charge Characteristics

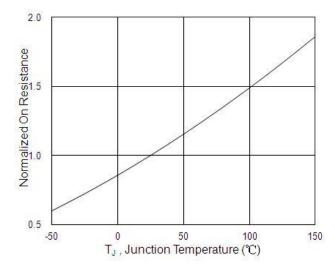
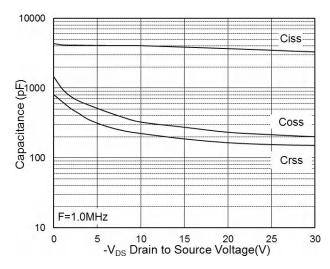


Fig.6 Normalized R_{DSON} vs T_J



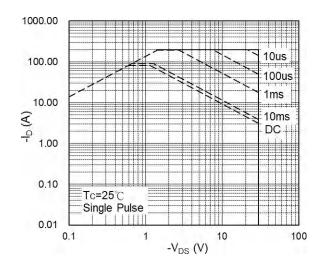


Fig.7 Capacitance

Fig.8 Safe Operating Area

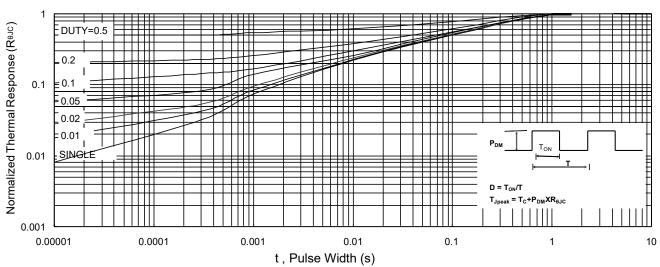


Fig.9 Normalized Maximum Transient Thermal Impedance

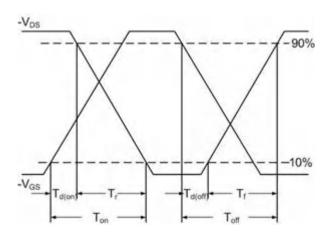


Fig.10 Switching Time Waveform

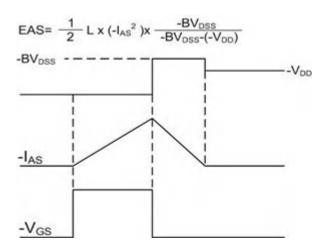
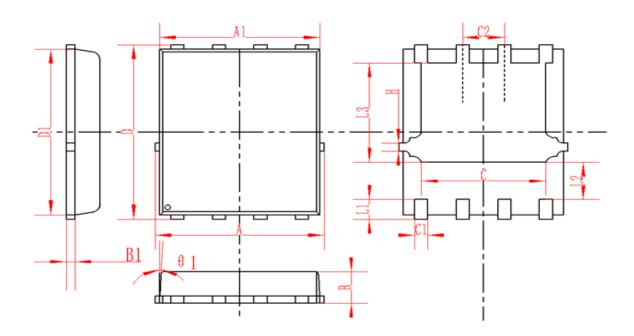


Fig.11 Unclamped Inductive Switching Waveform

DFN5X6-8L Package Information



SYMBOL	MM		INCH			
	MIN	NOM	MAX	MIN	NOM	MAX
Α	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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